**Bottom View** 

Vishay Siliconix

# N-Channel 45 V (D-S) 175 °C MOSFET

# PowerPAK® SO-8DC

Top View

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	45				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00120				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00180				
Q <sub>g</sub> typ. (nC)	50.5				
I <sub>D</sub> (A) <sup>a</sup>	228				
Configuration	Single				

#### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- 45 V Drain-source break-down voltage
- Tuned for low Q<sub>g</sub> and Q<sub>oss</sub>
- 100 % R<sub>a</sub> and UIS tested

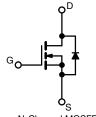
 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>



**FREE** 

#### **APPLICATIONS**

- Synchronous rectification
- High power density DC/DC
- Motor drive control



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8DC
Lead (Pb)-free and halogen-free	SiDR608EP-T1-RE3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	45	V
Gate-source voltage		V <sub>GS</sub>	+20, -16	7 v
Continuous drain current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C		228	
	T <sub>C</sub> = 70 °C		190	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	56 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		47 b, c	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	400	A
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		113	
	T <sub>A</sub> = 25 °C	ls —	6.8 b, c	
Single pulse avalanche current	l 0.1 mll	I <sub>AS</sub>	50	
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	125	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C		125	
	T <sub>C</sub> = 70 °C		87.5	10/
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	7.5 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C		5.25 b, c	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	00
Soldering recommendations (peak temperature) d, e		_	260	→ °C

#### **Notes**

- a. Based on T<sub>C</sub> = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8DC is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient a, b	t ≤ 10 s	$R_{thJA}$	15	20	
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	0.9	1.2	°C/W
Maximum junction-to-case (source)	Steady state	$R_{thJC}$	1.1	1.4	

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. Maximum under steady state conditions is 54  $^{\circ}\text{C/W}$

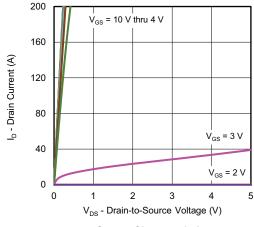
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	45	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	29	-	>//06	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.8	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.1	-	2.3	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$	-	-	± 100	nA	
7		V <sub>DS</sub> = 45 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 45 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50	-	-	Α	
Drain actives on state resistance ?	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	0.00100	0.00120		
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	0.00136	0.00180	Ω	
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A	-	120	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	8900	-	pF	
Output capacitance	C <sub>oss</sub>	V 00 V V 0 V f 1 MIL-	-	1244	-		
Reverse transfer capacitance	C <sub>rss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	120	-		
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.0135	0.0270	-	
Tatal acts alsoure		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$ $V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	111	167	nC	
Total gate charge	$Q_g$		-	50.5	76		
Gate-source charge	Q <sub>gs</sub>		-	26	-		
Gate-drain charge	Q <sub>gd</sub>		-	7.8	-		
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V	-	59	-		
Gate resistance	$R_{g}$	f = 1 MHz	0.3	0.88	1.5	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	19	38		
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 1 \Omega$	-	10	20		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 20 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	50	100		
Fall time	t <sub>f</sub>		-	8	16		
Turn-on delay time	t <sub>d(on)</sub>		-	52	104	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1 $\Omega$	-	86	172		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 20 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	50	100		
Fall time	t <sub>f</sub>		-	25	50		
<b>Drain-Source Body Diode Characteristic</b>	s			•			
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C		-	113	٨	
Pulse diode forward current ( $t_p = 100 \mu s$ )	I <sub>SM</sub>		-	-	400	- A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A	-	0.7	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	-	-	52	104	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	71	142	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_{J} = 25  ^{\circ}\text{C}$	-	32	-	ns	
Reverse recovery rise time	t <sub>b</sub>		_	20	_		

#### Notes

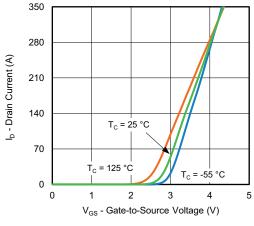
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

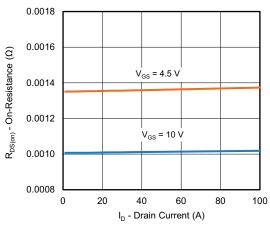




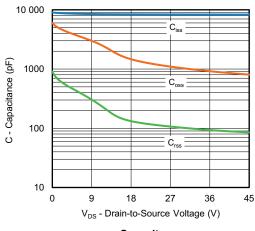




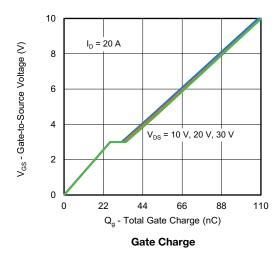
**Transfer Characteristics** 

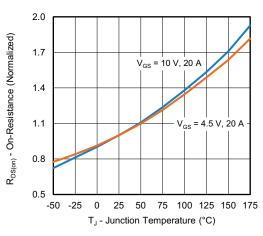


On-Resistance vs. Drain Current



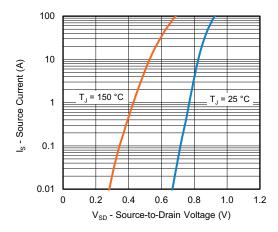
Capacitance



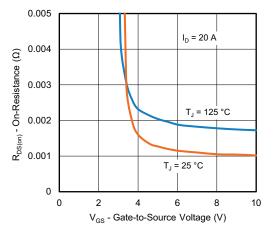


On-Resistance vs. Junction Temperature

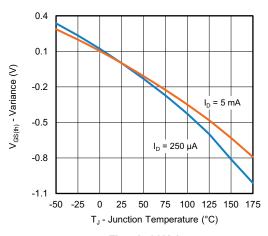




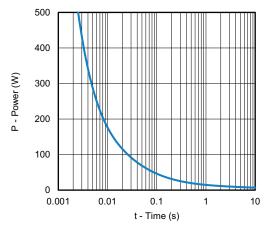
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

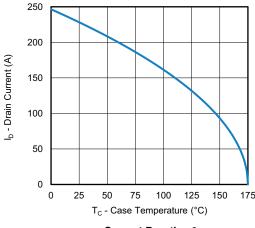


**Threshold Voltage** 

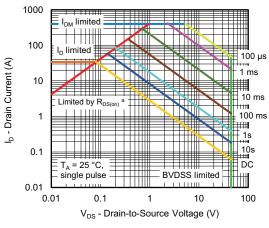


Single Pulse Power, Junction-to-Ambient

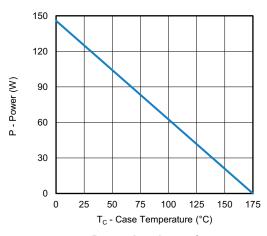




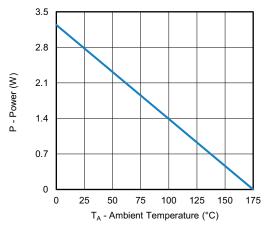




Safe Operating Area b



Power, Junction-to-Case



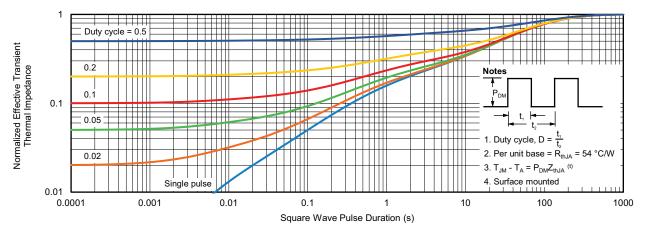
Power, Junction-to-Ambient

#### Notes

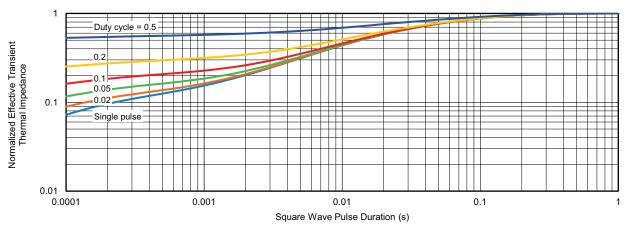
- a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit
- b. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

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Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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